

CERTIFICATE OF COMPLIANCE - RoHS Declaration -

NXP Semiconductors certifies that, to its best knowledge, semiconductor products designated to be:

- RoHS compliant (including all homogeneous sub-components – the pins, casing, internal parts) and meet the requirements of the EU-Directive 2002/95/EC (Restriction on Hazardous Substances, RoHS) and its amendments. This includes also the non use of DecaBromoDiphenylEther (Deca-BDE).

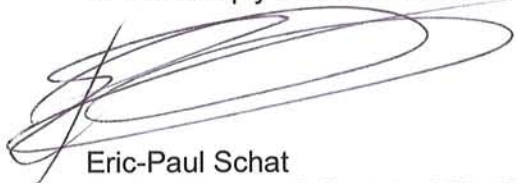
These semiconductor products can be recognized by the “RoHS compliant” logo on the box label. In addition, products that do not make use of a Lead exemption with the “Lead-free” logo. The intention is to make NXP products Lead-Free, when there is appropriate technology available and as long as there is no adverse effect on the NXP high quality standards.

Lead (Pb) is the last of the RoHS Substances to be removed since the other restricted substances were already not used in NXP semiconductor’s products. NXP’s term of “Lead-free” or “Pb-free” mean semiconductor products that are compatible with the current RoHS requirements for all six of the RoHS substances, including the requirement that Lead (Pb) does not exceed 1000ppm by weight, in all homogeneous subcomponent materials. Where designed to be soldered at high temperatures, NXP “Lead-free” products are suitable for use in specified “Lead-free” processes. This status is based on NXP’s understanding of RoHS and NXP’s knowledge of the materials that go into its products as of the date of disclosure of information.

To facilitate customer requirements to check compliance of the products of NXP Semiconductors, NXP has made the material content information available via the internet via: http://www.nxp.com/search/chemical_content/index.php

When reviewing the material content, a spreadsheet can be downloaded, for your convenience and further processing in chemical management systems like IMDS. Due to the availability of this service, it’s NXP policy not to upload such material content data in customer systems.

The signature below verifies that statements above, including but not limited to any material composition data are, to the best of our knowledge, valid and accurate. However, NXP cannot warrant that products from NXP’s customers, in which such NXP products are incorporated, will in turn comply with this RoHS Declaration.



Eric-Paul Schat
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